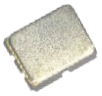
CRYSTAL OSCILLATOR (SPXO)

OUTPUT : LV-PECL, LVDS

Product Number
SG2520EGN: X1G005881xxxx15
SG2520VGN: X1G005901xxxx15

SG2520EGN
SG2520VGN



(2.5 × 2.0 × 0.74 mm)

- Frequency range : 25 MHz to 500 MHz
- Supply voltage : 1.8 V Typ. (LVDS only) / 2.5 V Typ. / 3.3 V Typ.
- Frequency tolerance : ±25 × 10^{-6}, ±30 × 10^{-6}, ±50 × 10^{-6}
- Operating temperature : -40 °C to +85 °C, -40 °C to +105 °C
- Function : Output enable (OE) or Standby ($\overline{ST}$)
- Phase jitter : 50 fs Max. (fo = 491.52 MHz)

Specifications (characteristics)

Item	Symbol	Specifications			Conditions / Remarks	
		LV-PECL	LVDS			
		SG2520EGN	SG2520VGN			
Output frequency range	fo	25 MHz to 500 MHz			Please contact us for available frequencies.	
Supply voltage	V_{CC}	D: 2.5 V ± 5 % C: 3.3 V ± 5 %	E: 1.8 V ± 5 %	D: 2.5 V ± 5 % C: 3.3 V ± 5 %		
Storage temperature	T_stg	-55 °C to +125 °C				
Operating temperature	T_use	G: -40 °C to +85 °C, H: -40 °C to +105 °C				
Frequency tolerance	f_tol	D: ±25 × 10^{-6} Max.			Includes initial frequency tolerance, frequency / temperature characteristics, frequency / voltage coefficient and 10 years aging (+25 °C)	
		E: ±30 × 10^{-6} Max.				
		J: ±50 × 10^{-6} Max.				
Current consumption	I_{CC}	60 mA Max.	–		OE or $\overline{ST}$ = V_{CC}, L_ECL = 50 Ω	
		–	25 mA / – / 25 mA Max.	25 mA / 30 mA / 25 mA Max.	OE or $\overline{ST}$ = V_{CC}, Output option: A / B / C	25 MHz ≤ fo < 212 MHz
				28 mA / 35 mA / 28 mA Max.		212 MHz ≤ fo < 392 MHz
				28 mA / 35 mA / 30 mA Max.		392 MHz ≤ fo ≤ 500 MHz
Disable current	I_dis	35 mA Max.	20 mA Max.		OE = GND	
Stand-by current	I_std	30 µA Max.			$\overline{ST}$ = GND, T_use Max. = +85 °C	
		60 µA Max.			$\overline{ST}$ = GND, T_use Max. = +105 °C	
Symmetry	SYM	45 % to 55 %			At output crossing point	
Output voltage (LV-PECL)	V_{OH}	V_{CC} - 1.1 V Min.	–		Output option: A, DC characteristic	
	V_{OL}	V_{CC} - 1.5 V Max.				
Differential swing	V_{SW}	0.8 V to 2.0 V	500 mV to 900 mV		Output option: A	
		–	–	400 mV to 1 000 mV	Output option: B	
		–	600 mV to 1 200 mV		Output option: C	
Output voltage (LVDS)	V_{OD}	–	250 mV to 450 mV		Output option: A	Differential output voltage, V_{OD1}, V_{OD2}
			–	200 mV to 500 mV	Output option: B	
			300 mV to 600 mV		Output option: C	
	dV_{OD}	–	50 mV Max.		dV_{OD} = | V_{OD1} - V_{OD2} |	
	V_{OS}	–	0.65 V to 0.85 V	1.15 V to 1.35 V	Offset voltage, V_{OS1}, V_{OS2}	
	dV_{OS}	–	50 mV Max.		dV_{OS} = | V_{OS1} - V_{OS2} |	
Output load condition	L_ECL	50 Ω	–		Terminated to V_{CC} - 2.0 V	
	L_LVDS	–	100 Ω		Output option: A, C	Connected between OUT and $\overline{OUT}$
			50 Ω		Output option: B	
Input voltage	V_{IH}	70 % V_{CC} Min.			OE or $\overline{ST}$ terminal	
	V_{IL}	30 % V_{CC} Max.				
Rise/Fall times	tr/tf	0.35 ns Max.			LV-PECL: 20 % - 80 % (V_{OH} - V_{OL}) LVDS: 20 % - 80 % differential output peak to peak	
Start-up time	t_str	10 ms Max.			t = 0 at 90 % V_{CC}	
Phase jitter	t_{PJ}	250 fs Max.	400 fs Max.	250 fs Max.	25 MHz ≤ fo < 100 MHz	Offset frequency fo < 50 MHz: 12 kHz to 5 MHz fo ≥ 50 MHz: 12 kHz to 20 MHz
		90 fs Max.	130 fs Max.	100 fs Max.	100 MHz ≤ fo ≤ 156 MHz	
		70 fs Max.	70 fs Max.	60 fs Max.	156 MHz < fo ≤ 212 MHz	
		60 fs Max.	60 fs Max.	50 fs Max.	212 MHz < fo ≤ 391 MHz	
		50 fs Max.	60 fs Max.	50 fs Max.	391 MHz < fo ≤ 500 MHz	

Product Name (Standard form): SG2520 EGN 156.250000MHz C D H P Z A
① ② ③ ④⑤⑥⑦⑧⑨

①Model ②Output (E: LV-PECL, V: LVDS) ③Frequency ④Supply voltage ⑤Frequency tolerance
⑥Operating temperature ⑦Function ⑧Output disable type (Z: High impedance) ⑨Output option

④Supply voltage	
C	3.3 V Typ.
D	2.5 V Typ.
E*	1.8 V Typ.

* "E" is only for SG2520VGN

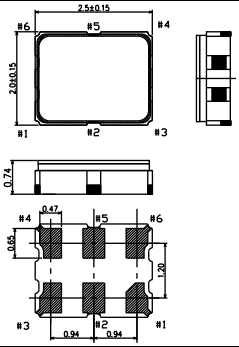
⑤Freq. tolerance	
D	±25 × 10^{-6}
E	±30 × 10^{-6}
J	±50 × 10^{-6}

⑥Operating temp.	
G	-40 °C to +85 °C
H	-40 °C to +105 °C

⑦Function	
P	OE
S	$\overline{ST}$

⑨Output option		
	SG2520EGN	SG2520VGN
A	Default	L_LVDS = 100 Ω, V_{OD} = 250 mV to 450 mV
B	-	L_LVDS = 50 Ω, V_{OD} = 200 mV to 500 mV
C	-	L_LVDS = 100 Ω, V_{OD} = 300 mV to 600 mV

External dimensions (Unit:mm)

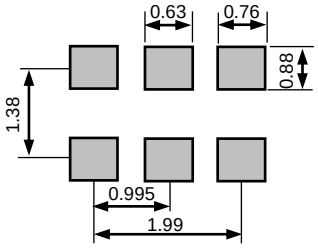


Pin map

Pin	Connection
1	OE
2	N.C. (Open or V_{CC})
3	GND
4	OUT
5	$\overline{OUT}$
6	V_{CC}

Note:
OE pin = HIGH or "Open": Specified frequency output.
OE pin = LOW: Output is high impedance

Footprint (Recommended) (Unit:mm)



In order to achieve optimum jitter performance, it is recommended that 0.1 µF and 10 µF bypass capacitors should be connected between V_{CC} and GND and placed as close to the V_{CC} pin as possible.

PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

WORKING FOR HIGH QUALITY

In order provide high quality and reliable products and services than meet customer needs, Seiko Epson made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired IATF 16949 certification that is requested strongly by major automotive manufacturers as standard.

IATF 16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

►Explanation of the mark that are using it for the catalog

	►Pb free.
	►Complies with EU RoHS directive. *About the products without the Pb-free mark. Contains Pb in products exempted by EU RoHS directive. (Contains Pb in sealing glass, high melting temperature type solder or other.)
	►Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.
	►Designed for automotive applications related to driving safety (Engine Control Unit, Air Bag, ESC etc).